

DECLARATION OF INVENTORSHIP AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled :

METHOD OF PLATING METAL LAYER OVER ISOLATED PADS ON
SEMICONDUCTOR PACKAGE SUBSTRATE

The specification of which

(check one) _____ is attached hereto.
_____ was filed on _____
under Application Serial No. _____ and was
amended on _____
_____ (if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information which is material to Patentability as defined in 37 CFR § 1.56.

I hereby claim foreign priority benefits under 35 USC § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

APPLICATION NUMBER
092109029

COUNTRY
TAIWAN, R.O.C.

FILING DATE
April 18, 2003

I hereby claim the benefit under 35 USC §120 of any United States application(s) listed below and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC § 112, I acknowledge the duty to disclose to the Office information which is material to patentability as defined in CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION NUMBER FILING DATE STATUS
(Patented, Pending, Abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Address all correspondence to: Mr. John Carson
Ms. Melinda Hallmark
FULBRIGHT & JAWORSKI L.L.P
865 South Figueroa Street, 29th Floor
Los Angeles, California 90017-2576, U.S.A.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 USC 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole or first inventor Wei-Sheng YANG
 Inventor's Signature Wei-Sheng yang Date JULY 4, 2003
 Residence Hsin-Chu City, Taiwan Citizenship TAIWAN, R.O.C.
 Post Office Address No. 6, Li-Hsin Road, Science-Based Industrial Park,
Hsin-Chu, Taiwan, R.O.C.

Full name of second inventor Chih-Liang CHU
 Inventor's Signature Chih-Liang Chu Date JULY 4, 2003
 Residence Hsin-Chu City, Taipei Citizenship TAIWAN, R.O.C.
 Post Office Address No. 6, Li-Hsin Road, Science-Based Industrial Park,
Hsin-Chu, Taiwan, R.O.C.

Full name of third joint inventor, if any Kuo-Sheng WEI
 Inventor's Signature Kuo Sheng Wei Date JULY 4, 2003
 Residence Hsin-Chu City Citizenship TAIWAN, R.O.C.
 Post Office Address No. 6, Li-Hsin Road, Science-Based Industrial Park,
Hsin-Chu, Taiwan, R.O.C.

Full name of fourth joint inventor, if any _____
 Inventor's Signature _____ Date _____
 Residence _____ Citizenship _____
 Post Office Address _____

Full name of fifth joint inventor, if any _____
 Inventor's Signature _____ Date _____
 Residence _____ Citizenship _____
 Post Office Address _____

Full name of sixth joint inventor, if any _____
 Inventor's Signature _____ Date _____
 Residence _____ Citizenship _____
 Post Office Address _____